Surface Mount Ultrafast Plastic Rectifiers

DO-214AB (SMC)

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Ultrafast recovery times for high efficiency
- Low forward voltage, low power loss
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

RoHS COMPLIANT

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converter and inverter for both consumer and automotive.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3 A
V_{RRM}	100 V, 150 V, 200 V
t_{rr}	25 ns
V_F	0.90 V
T_J max.	175 °C

MECHANICAL DATA

Case: DO-214AB (SMC)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	ESH3B	ESH3C	ESH3D	UNIT
Device marking code		EHB	EHC	EHD	
Maximum repetitive peak reverse voltage	V_{RMM}	100	150	200	V
Maximum RMS voltage	V_{RMS}	70	105	140	V
Maximum DC blocking voltage	V_{DC}	100	150	200	V
Maximum average forward rectified current (Fig. 1)	$I_{F(AV)}$	3.0			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	125			A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 175			°C

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)					
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**VALUE**	**UNIT**
Maximum instantaneous forward voltage (1)	I_F = 3 A		V_F	0.90	V
Maximum DC reverse current at rated DC blocking voltage		T_A = 25 °C T_A = 125 °C	I_R	5.0 150	µA
Maximum reverse recovery time	I_F = 0.5 A, I_R = 1 A, I_{rr} = 0.25 A		t_{rr}	25	ns
Typical reverse recovery time	I_F = 3 A, V_R = 30 V, dI/dt = 50 A/µs, I_{rr} = 10 % I_{RM}	T_J = 25 °C T_J = 100 °C	t_{rr}	40 55	ns
Typical stored charge	I_F = 3 A, V_R = 30 V, dI/dt = 50 A/µs, I_{rr} = 10 % I_{RM}	T_J = 25 °C T_J = 100 °C	Q_{rr}	25 60	nC
Typical junction capacitance	4.0 V, 1 MHz		C_J	70	pF

Note:

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)					
PARAMETER	**SYMBOL**	**ESH3B**	**ESH3C**	**ESH3D**	**UNIT**
Typical thermal resistance (1)	$R_{\theta JA}$ $R_{\theta JL}$	50 15			°C/W

Note:

(1) Units mounted on P.C.B. with 12.0 x 12.0 mm land areas

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
ESH3D-E3/57T	0.211	57T	850	7" diameter plastic tape and reel
ESH3D-E3/9AT	0.211	9AT	3500	13" diameter plastic tape and reel
ESH3DHE3/57T (1)	0.211	57T	850	7" diameter plastic tape and reel
ESH3DHE3/9AT (1)	0.211	9AT	3500	13" diameter plastic tape and reel

Note:

(1) Automotive grade AEC Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

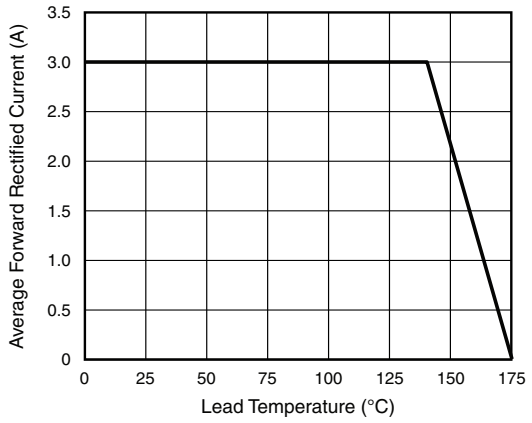


Figure 1. Maximum Forward Current Derating Curve

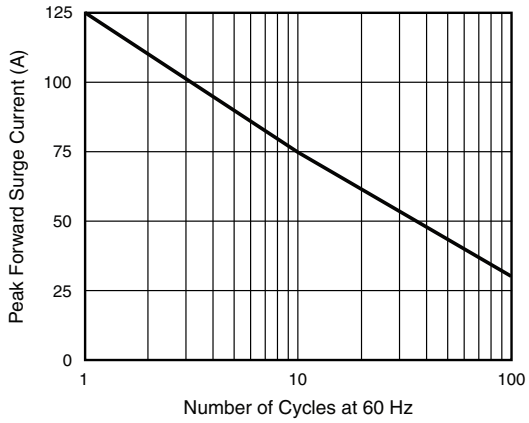


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

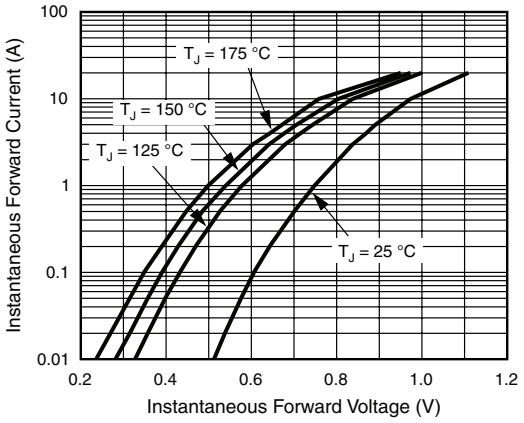


Figure 3. Typical Instantaneous Forward Characteristics

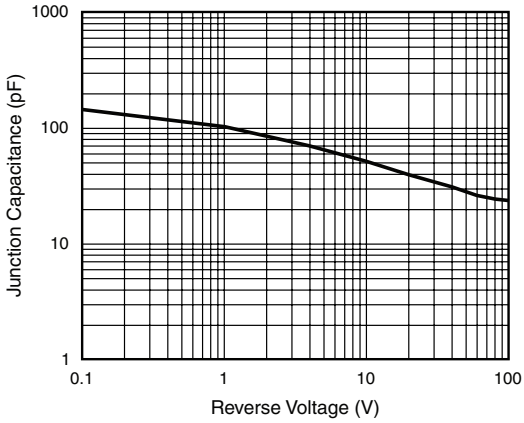


Figure 5. Typical Junction Capacitance

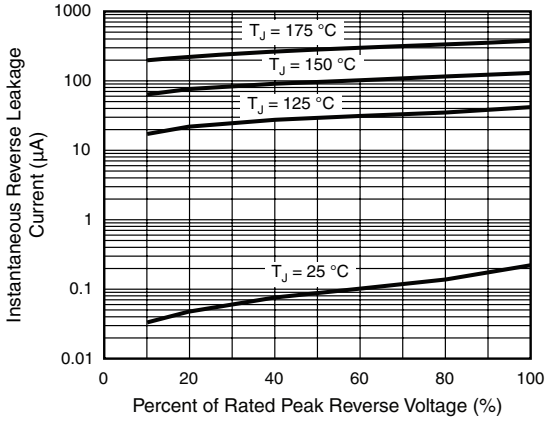


Figure 4. Typical Reverse Leakage Characteristics

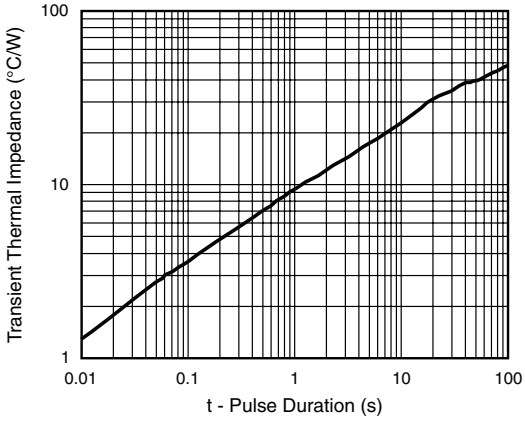
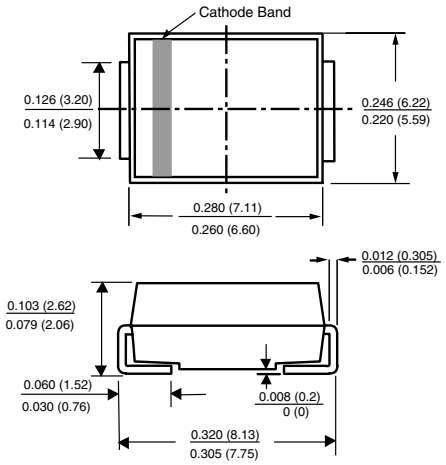


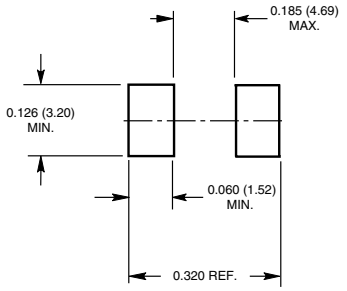
Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AB (SMC)



Mounting Pad Layout



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